

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON) max}	I _{D max} T _A = +25°C
001/	9mΩ @ V _{GS} = 4.5V	15.2A
20V	15mΩ @ V _{GS} = 2.5V	13.8A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions

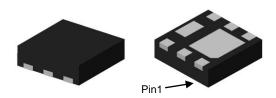
Features

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

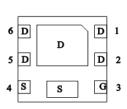
- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208@4
- Weight: 0.007 grams (Approximate)

U-DFN2020-6 (Type F)

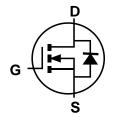




Bottom View



Pin Out Bottom View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2015UFDF-7	U-DFN2020-6 (Type F)	3,000
DMN2015UFDF-13	U-DFN2020-6 (Type F)	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



5N = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016		2017	20	18	2019		2020	2	2021
Code	С		D		Е	l l	F	G		Н		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	20	V
Gate-Source Voltage			V_{GSS}	±12	V
Continuous Dusin Compant (Nata CVV 45V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	Ι _D	11.6 9.3	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	Ι _D	15.2 12.2	А
Pulsed Drain Current (380µs pulse, duty cycle = 1%)			I _{DM}	70	Α
Maximum Body Diode Continuous Current (Note 6)			Is	2.1	Α
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	23	Α
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	28	mJ

Thermal Characteristics

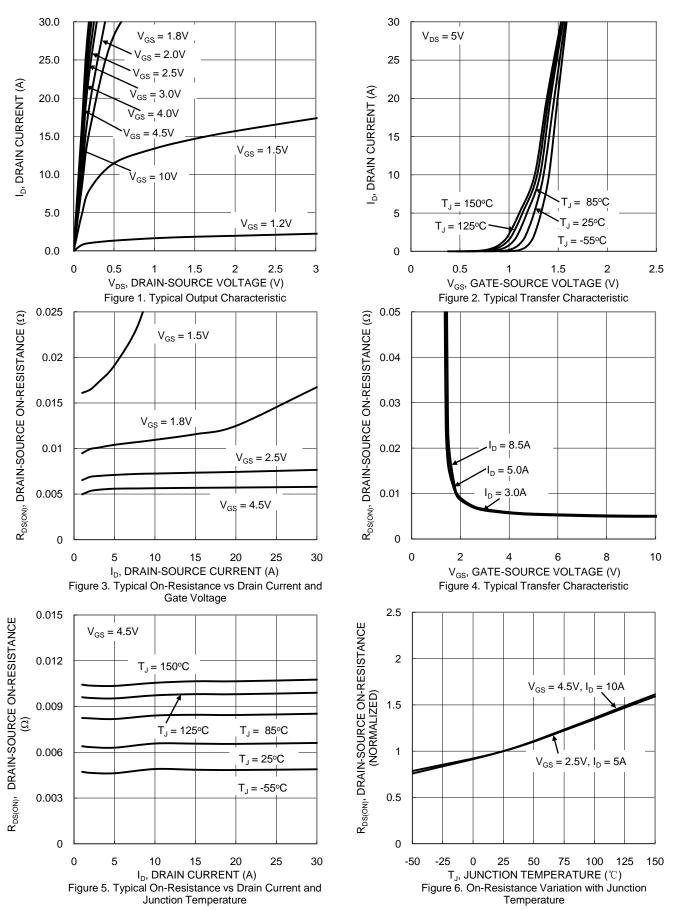
Characteristic		Symbol	Value	Units	
Total Power Discination (Note 5)	T _A = +25°C	D.	0.8	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_{D}	0.5	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	<u> </u>	159	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	110	C/VV	
Total Power Dissipation (Note 6)	T _A = +25°C	D	1.8	W	
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.2	VV	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	D.	70		
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	40	°C/W	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	14		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						•
Drain-Source Breakdown Voltage	BV _{DSS}	20	I		٧	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		I	1	μΑ	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}		I	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1.2	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			6.8	9		$V_{GS} = 4.5V, I_D = 8.5A$
Static Drain-Source On-Resistance	D-s/s/		7.6	15	mΩ	$V_{GS} = 2.5V, I_D = 8.5A$
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	11	30	11122	$V_{GS} = 1.8V, I_D = 5A$
			18	50		$V_{GS} = 1.5V, I_D = 3A$
Diode Forward Voltage	V_{SD}	_	0.75	1.2	V	$V_{GS} = 0V$, $I_{S} = 8.5A$
DYNAMIC CHARACTERISTICS (Note 9)						_
Input Capacitance	C _{iss}	_	1439	_	pF	101/1/
Output Capacitance	Coss	_	224	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C_{rss}	_	202	-	рF	1 – 1.000112
Gate Resistance	R_g	-	1.3		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Q_g		19.3	l	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	-	42.3		nC	10)/ 1 0.54
Gate-Source Charge	Qgs	_	2.5	_	nC	$V_{DS} = 10V, I_{D} = 8.5A$
Gate-Drain Charge	Q _{gd}	_	4.5	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	4.7	_	ns	
Turn-On Rise Time	t _R	_	6.9	_	ns	$V_{DS} = 10V, I_{D} = 8.5A$
Turn-Off Delay Time	t _{D(OFF)}		23	_	ns	$V_{GS} = 4.5V, R_{G} = 1.8\Omega$
Turn-Off Fall Time	t _F	_	7.4	_	ns	7
Reverse Recovery Time	t _{RR}	_	11.6	_	ns	1 0 5 0 32/34 04 0 04 0 04/34
Reverse Recovery Charge	Q_{RR}	_	4.6	_	nC	I _F = 8.5A, di/dt = 210A/μs

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.









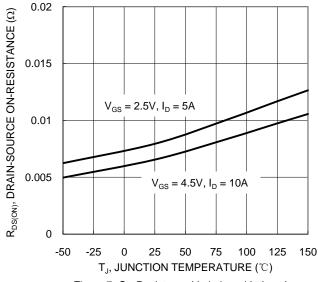
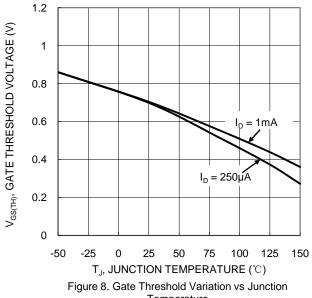


Figure 7. On-Resistance Variation with Junction Temperature



Temperature

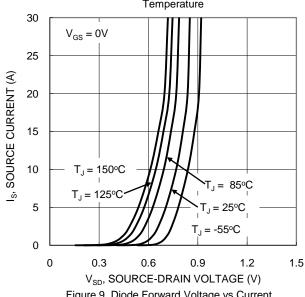
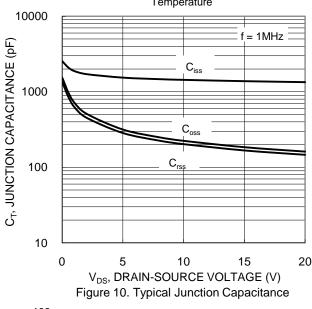
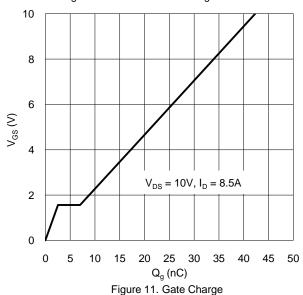
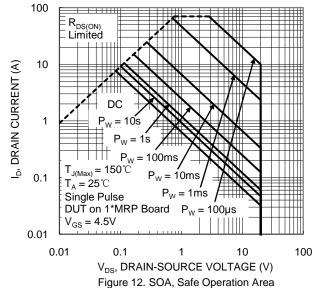


Figure 9. Diode Forward Voltage vs Current









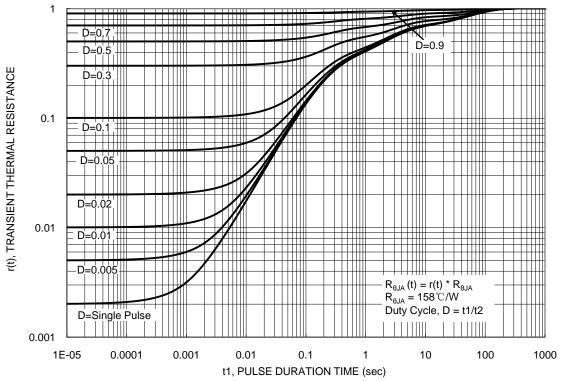


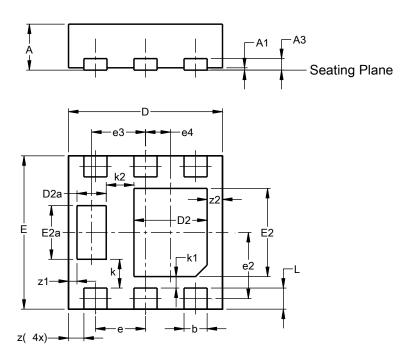
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

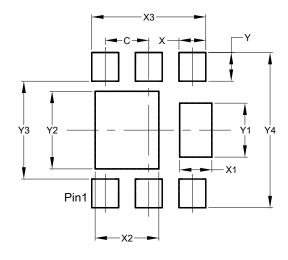


	U-DFN	2020-6	
	(Тур	oe F)	
Dim	Min	Max	Тур
Α	0.57	0.63	0.60
A1	0.00	0.05	0.03
A3	-	-	0.15
b	0.25	0.35	0.30
D	1.95	2.05	2.00
D2	0.85	1.05	0.95
D2a	0.33	0.43	0.38
Е	1.95	2.05	2.00
E2	1.05	1.25	1.15
E2a	0.65	0.75	0.70
е		0.65 BS	
e2	C).863 BS	SC
е3		0.70 BS	С
e4	C).325 BS	SC
k	(0.37 BS	С
k1		0.15 BS	С
k2		0.36 BS	С
L	0.225	0.325	0.275
Z		0.20 BS	С
z1	C).110 BS	SC
z2		0.20 BS	С
All D	imens	ions in	mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



	Dimensions
(in mm)	
C 0.650	С
X 0.400	Х
X1 0.480	X1
X2 0.950	X2
X3 1.700	Х3
Y 0.425	Y
Y1 0.800	Y1
Y2 1.150	Y2
Y3 1.450	Y3
Y4 2.300	Y4



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